Brief Description

The ZSSC3122 is a CMOS integrated circuit for accurate capacitance-to-digital conversion and sensor-specific correction of capacitive sensor signals. Digital compensation of sensor offset, sensitivity, and temperature drift is accomplished via an internal digital signal processor running a correction algorithm with calibration coefficients stored in a non-volatile EEPROM.

The ZSSC3122 is configurable for capacitive sensors with capacitances up to 10pF and a sensitivity of 125aF/LSB. It is compatible with both single capacitive sensors (both terminals must be accessible) and differential capacitive sensors. Measured and corrected sensor values can be output as I2C, SPI, PDM, or alarms.

The I2C interface can be used for a simple PC-controlled calibration procedure to program a set of calibration coefficients into an on-chip EEPROM. The calibrated ZSSC3122 and a specific sensor are mated digitally: fast, precise, and without the cost overhead of trimming by external devices or laser.

Available Support

- ZSSC3122 SSC Evaluation Kit available: SSC Evaluation Board, samples, software, documentation.
- Support for industrial mass calibration available.
- Quick circuit customization option for large production volumes.

Features

- Maximum target input capacitance: 10pF
- Sampling rates as fast as 0.7ms at 8-bit resolution; 1.6ms at 10-bit; 5.0ms at 12-bit; 18.5ms at 14-bit
- Digital compensation of sensor: piece-wise 1st and 2nd order sensor compensation or up to 3rd order single-region sensor compensation
- Digital compensation of 1st and 2nd order temperature gain and offset drift
- Internal temperature compensation reference (no external components)
- Programmable capacitance span and offset
- Layout customized for die-die bonding with sensor for low-cost, high-density chip-on-board assembly
- Accuracy as high as ±0.25% FSO@ -20 to 125°C, 3V, 5V, Vsupply ±10% (see data sheet section 1.3 for restrictions)
- Minimized calibration costs: no laser trimming, one-pass calibration using a digital interface
- Excellent for low-power battery applications
- Two interface options
  - I2C or SPI interface—easy connection to a microcontroller
  - PDM outputs (Filtered Analog Ratiometric) for both capacitance and temperature
- Up to two alarms that can act as full push-pull or open-drain switches
- Supply voltage: 1.8 to 5.5V
- Typical current consumption 650μA down to 60μA depending on configuration
- Typical Sleep Mode current: ≤ 1μA at 85°C
- Operation temperature: −20°C to +125°C
- Die or TSSOP14 package

Application Circuit: Digital Output, Alarms

![Application Circuit Diagram]
ZSSC3122 Block Diagram

Application: Analog Output

VDD (1.8V to 5.5V) 0.1µF Vcore VSS

0.1µF

GND

0.1µF

VDD Vcore VSS

0.1µF

GND

0.1µF

0.1µF

Application: Differential Capacitance Input

VDD (1.8V to 5.5V) 0.1µF

0.1µF

VDD Vcore VSS

0.1µF

GND

0.1µF

0.1µF

Cap. Analog Output

Temp Analog Output

PDM_C PDM_T

Alarm_High

Alarm_Low

Ready

PDM

iC / SPI

Low Alarm

High Alarm

SS

Alarm_Low

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